# SPECIFICATIONS

Custome	er				
Product Name		Multi-layer Chip Power Inductor			
Sunlord Part Number		MPH160809S Series			
Customer Part Number					
[⊠New Released	sed] SPEC No.: MPH0402210000				
【This SPEC is total ' 【ROHS, Halogen-Fre		• .		nd appendix. ]	
	Approved	By Check	ced By	Issued By	
ddress: Sunlord Indu	strial Park, Da		Zone, Bac	an, Shenzhen,	Co., Ltd. China 518110 lord@sunlordinc.com
ddress: Sunlord Indu	strial Park, Da 33 Fax	afu Industrial 2 x: 0086-755-82	Zone, Bac	an, Shenzhen,	China 518110
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**Sunlord** Business categories: Level 0 (general confidential) **Specifications for Multi-layer Chip Power Inductor** 

Page 2 of 10

# 【Version change history】

Rev.	Effective Date	Changed Contents	Change reasons	Approved By
01	/	New release	1	Hai Guo

# Caution

All products listed in this specification are developed, designed and intended for use in general electronics equipment. The products are not designed or warranted to meet the requirements of the applications listed below, whose performance and/or quality require especially high reliability, or whose failure, malfunction or trouble might directly cause damage to society, person, or property. Please understand that we are not responsible for any damage or liability caused by use of the products in any of the applications below. Please contact us for more details if you intend to use our products in the following applications.

- 1. Aircraft equipment
- 2. Aerospace equipment
- 3. Undersea equipment
- 4. nuclear control equipment
- 5. military equipment
- 6. Power plant equipment
- 7. Medical equipment
- 8. Transportation equipment (automobiles, trains, ships,etc.)
- 9. Traffic signal equipment
- 10. Disaster prevention / crime prevention equipment
- 11. Data-processing equipment
- 12. Applications of similar complexity or with reliability requirements comparable to the applications listed in the above

# 1. Scope

This specification applies to MPH160809S Series of multi-layer chip power inductors.

# 2. Product Description and Identification (Part Number)

1) Description

MPH160809S Series of multi-layer chip power inductors

2) Product Identification (Part Number)

<u>MPH</u>	<u>160809</u>	<u>s</u>	XXX		<u>T</u>
1	2	3	4	(5)	6

<b>①Туре</b>	
MPH	Monolithic Type Power Inductor

③Feature Type	
S	Standard

⑤Inductance Tolerance		
M	±20%	
N	±30%	

②External Dimensions (L x W xT) (mm)	
160809	1.6×0.8×0.9

④Nominal Inductance		
Example	Nominal Value	
R68	0.68µH	
2R2	2.2µH	

@Packing	
Т	Tape Carrier Package

#### 3. Electrical Characteristics

Please refer to Appendix A (Page 10).

- 1) Operating and storage temperature range (individual chip without packing): -55°C ~ +125°C (Including Self-heating)
- 2) Storage temperature range (packaging conditions): -10  $^{\circ}$ C ~+40  $^{\circ}$ C and RH 70% (Max.)

W

0.8±0.15

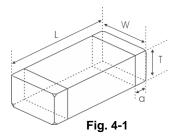
[0.031±0.006]

# 4. Shape and Dimensions

Type

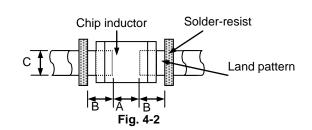
160809

- 1) Dimensions and recommended PCB pattern for reflow soldering: See Fig.4-1, Fig.4-2 and Table 4-1.
- 2) Structure: See Fig. 4-3 and Fig. 4-4.



1.60±0.15

[0.063±0.006]



[Table 4-1]

[0.031±0.006]

T a A B C

0.8±0.15 0.3±0.2 0.70 0.70 1.00

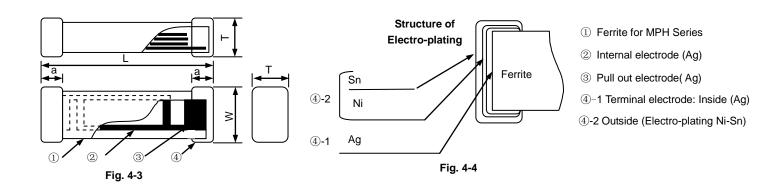
[0.012±0.008]

0.70

Unit: mm [inch]

1.0

0.70



# 3) Material Information: See Table 4-2.

[Table 4-2]

Code	Part Name	Material Name
1	Ferrite Body	Ferrite Powder
2	Inner Coils	Silver Paste
3	Pull-out Electrode (Ag)	Silver Paste
<b>4</b> -1	Terminal Electrode: Inside Ag	Termination Silver Composition
<b>4</b> -2	Electro-Plating: Ni/Sn plating	Plating Chemicals

#### 5. Test and Measurement Procedures

# **5.1 Test Conditions**

- 5.1.1Unless otherwise specified, the standard atmospheric conditions for measurement/test as:
  - a. Ambient Temperature: 20±15℃
  - b. Relative Humidity: 65±20%
  - c. Air Pressure: 86kPa to 106kPa
- 5.1.2If any doubt on the results, measurements/tests should be made within the following limits:
  - a. Ambient Temperature: 20±2°C
  - b. Relative Humidity: 65±5%
  - c. Air Pressure: 86kPa to 106kPa

#### 5.2 Visual Examination

a. Inspection Equipment: 20x magnifier

#### 5.3 Electrical Test

- 5.3.1 DC Resistance (DCR)
  - a. Refer to Appendix A.
  - b. Test equipment (Analyzer): High Accuracy Milliohmmeter-HP4338B or equivalent.

### 5.3.2 Inductance (L)

- a. Refer to Appendix A.
- b. Test equipment: High Accuracy RF Impedance /Material Analyzer-HP4291B+HP16192A or equivalent.
- c. Test signal: -20dBm or 50mV.
- d. Test frequency refers to **Appendix A**.
- 5.3.3 Temperature Rise Current (Irms)
  - a. Refer to Appendix A.
  - b. Test equipment (see Fig. 5.3.3-1): Electric Power, Electric current meter, Thermometer.
  - c. Measurement method (see Fig. 5.3.3-1):
    - 1. Set test current to be 0mA.
    - 2. Measure initial temperature of chip surface.
    - 3. Gradually increase voltage and measure chip temperature for corresponding current.
    - 4. Definition of Temperature Rise Current (Irms): Irms is direct electric current as chip surface temperature rose just 40℃ against chip initial surface temperature (Ta) (see **Fig. 5.3.3-2**)

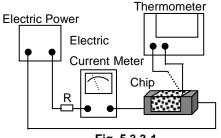


Fig. 5.3.3-1

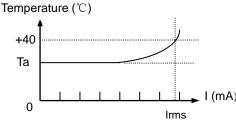


Fig. 5.3.3-2

# 5.3.4 Saturation Current (Isat)

- a. Refer to Appendix A.
- b. Test equipment: HP6632B system DC power supply, HP4291B+HP16192A+HP16200A or equivalent.
- c. Measurement method:
  - 1. Measurement conditions of initial inductance L: Measuring Frequency: 1MHz.

Test Current: 1mA.

2. Definition of Saturation Current (Isat): Isat is the value of DC current as inductance L ( $\mu$ H) decreased just 30% against initial value (see Fig. 5.3.4-1).

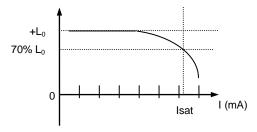


Fig. 5.3.4-1

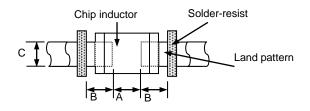
# 5.3.5Self-Resonant Frequency (SRF)

- a. Refer to Appendix A.
- b. Test equipment: High Accuracy RF Impedance /Material Analyzer-HP4291B+HP16192A or equivalent.
- c. Test signal: -20dBm or 50 mV.

# 5.4 Reliability Test

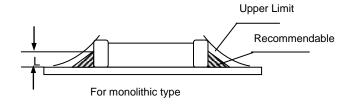
Α	В	С
0.70	0.70	1.0

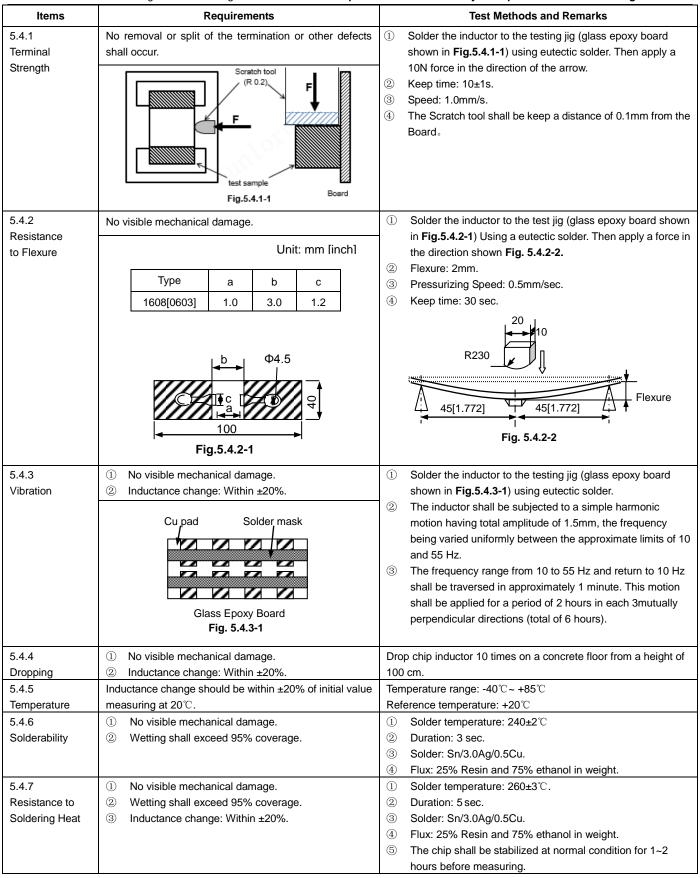
Unit: mm



- \* The thickness of Stencil is 0.08mm~0.1mm,add the standard thickness of solder paste:0.10mm~0.15mm.
- \* Solder shall be used as shown below.

1/3T ≤L≤T
(T: height of electrode)





Items	Requirements	Test Methods and Remarks
5.4.8 Thermal Shock	① No mechanical damage. ② Inductance change: Within ±20%.  30 min.  30 min.  Ambient Temperature  -40 °C  30 min.  20sec. (max.)	<ol> <li>Temperature, Time: (See Fig.5.4.8-1)         -40 °C for 30±3 min→ 85 °C for 30±3min.</li> <li>Transforming interval: 20 sec.(max.).</li> <li>Tested cycle: 100 cycles.</li> <li>The chip shall be stabilized at normal condition for 1~2 hours before measuring.</li> </ol>
5.4.9 Resistance to Low Temperature	No mechanical damage.     Inductance change: Within ±20%.	<ol> <li>Temperature: -40±2 °C</li> <li>Duration: 1000<sup>+24</sup> hours.</li> <li>The chip shall be stabilized at normal condition for 1~2 hours before measuring.</li> </ol>
5.4.10 Resistance to High Temperature	No mechanical damage.     Inductance change: Within ±20%.	Temperature: 85±2°C     Duration: 1000 <sup>+24</sup> hours.     The chip shall be stabilized at normal condition for 1~2 hours before measuring.
5.4.11 Damp Heat (Steady States)	No visible mechanical damage.     Inductance change: Within ±20%.	<ol> <li>Temperature: 60±2°C</li> <li>Humidity: 90% to 95% RH.</li> <li>Duration: 1000<sup>+24</sup> hours.</li> <li>The chip shall be stabilized at normal condition for 1~2 hours before measuring.</li> </ol>

# 6. Packaging and Storage

# 6.1 Packaging

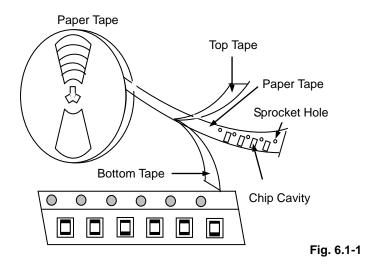
Tape Carrier Packaging:

Packaging code: T

- a. Tape carrier packaging are specified in attached figure Fig.6.1-1~3
- b. Tape carrier packaging quantity please see the following table:

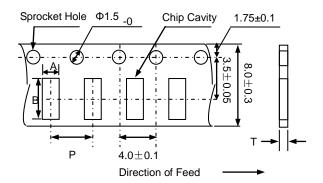
Type	1608[0603]				
T(mm)	0.8±0.15				
Tape	Paper Tape				
Quantity	4K				

- c. Reel shall be packaged in vinyl bag.
- d. Maximum of 5 or 10 reels bags shall be packaged in an inner box.
- e. Maximum of 6 or 10 inner boxes shall be packaged in an outer case.
- (1) Taping Drawings (Unit: mm)



**Remark:** The sprocket holes are to the right as the tape is pulled toward the user.

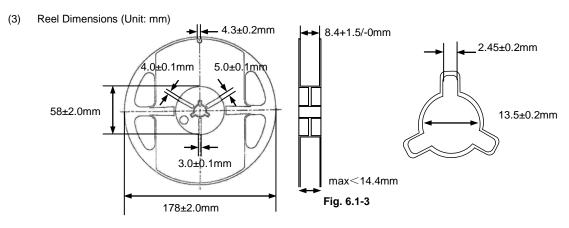
# (2) Taping Dimensions (Unit: mm)



 Type
 A
 B
 P
 T max

 MPH160809
 1.0±0.2
 1.8±0.2
 4.0±0.1
 1.1

Fig. 6.1-2



# 6.2 Storage

- a. The solderability of the external electrode may be deteriorated if packages are stored where they are exposed to high humidity. Package must be stored at 40℃ or less and 70% RH or less.
- b. The solderability of the external electrode may be deteriorated if packages are stored where they are exposed to dust of harmful gas (e.g. HCl, sulfurous gas of H<sub>2</sub>S).
- c. Packaging material may be deformed if package are stored where they are exposed to heat of direct sunlight.
- d. Solderability specified in **Clause 5.4.6** shall be guaranteed for 12 months from the date of delivery on condition that they are stored at the environment specified in **Clause 3**. For those parts, which passed more than 12 months shall be checked solder-ability before use.

## 7. Recommended Soldering Technologies

# 7.1 Reflowing Profile:

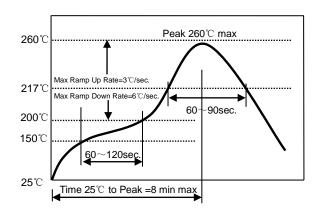
- △ Preheat condition: 150 ~200 °C/60~120sec.
- $\triangle$  Allowed time above 217°C: 60~90sec.
- △ Max temp: 260°C
- △ Max time at max temp: 10sec.△ Solder paste: Sn/3.0Ag/0.5Cu
- △ Solder paste: Sn/3.0Ag/0.5Cu△ Allowed Reflow time: 2x max

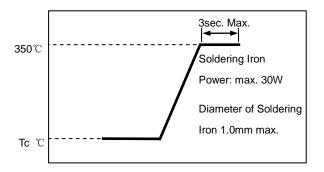
[Note: The reflow profile in the above table is only for qualification and is not meant to specify board assembly profiles. Actual board assembly profiles must be based on the customer's specific board design, solder paste and process, and should not exceed the parameters as the Reflow profile shows.]



- △ Iron soldering power: Max.30W
- $\triangle$  Pre-heating: 150  $^{\circ}$ C / 60sec.
- △ Soldering Tip temperature: 350°C Max.
- △ Soldering time: 3sec Max.
- △ Solder paste: Sn/3.0Ag/0.5Cu
- $\triangle$  Max.1 times for iron soldering

[Note: Take care not to apply the tip of the soldering iron to the terminal electrodes.]





Appendix A: Electrical Characteristics

Part Number	L (µH)	L Test Freq. (MHz)	S.R.F Min. (MHz)	DCR (Typ) (Ω)	DCR (Max) (Ω)	Temperature Rise Current Irms (max.) (mA)	Saturation Current Isat(Typ.) (mA)	Saturation Current Isat(Max.) (mA)	Thickness (mm) [inch]
MPH160809SR22□T	0.22	1	200	0.10	0.125	1250	1600	1350	-
MPH160809SR33□T	0.33	1	190	0.13	0.1625	1200	1500	1250	
MPH160809SR47□T	0.47	1	180	0.15	0.1875	1100	1200	1000	
MPH160809SR68□T	0.68	1	160	0.18	0.225	1150	1100	950	
MPH160809S1R0□T	1.0	1	125	0.20	0.250	1000	800	650	0.8±0.15
MPH160809S1R5□T	1.5	1	100	0.23	0.287	900	500	420	
MPH160809S1R8□T	1.8	1	100	0.26	0.325	800	400	300	
MPH160809S2R2□T	2.2	1	80	0.30	0.375	850	300	250	
MPH160809S2R7□T	2.7	1	90	0.34	0.425	750	220	180	
MPH160809S3R3□T	3.3	1	100	0.40	0.500	700	150	125	
MPH160809S4R7□T	4.7	1	65	0.40	0.500	700	80	65	
MPH160809S6R8□T	6.8	1	45	0.56	0.700	500	150	130	
MPH160809S100□T	10	1	35	0.36	0.468	500	80	60	

<sup>%</sup> □: Please specify the inductance tolerance code (M=±20%, N=±30%).